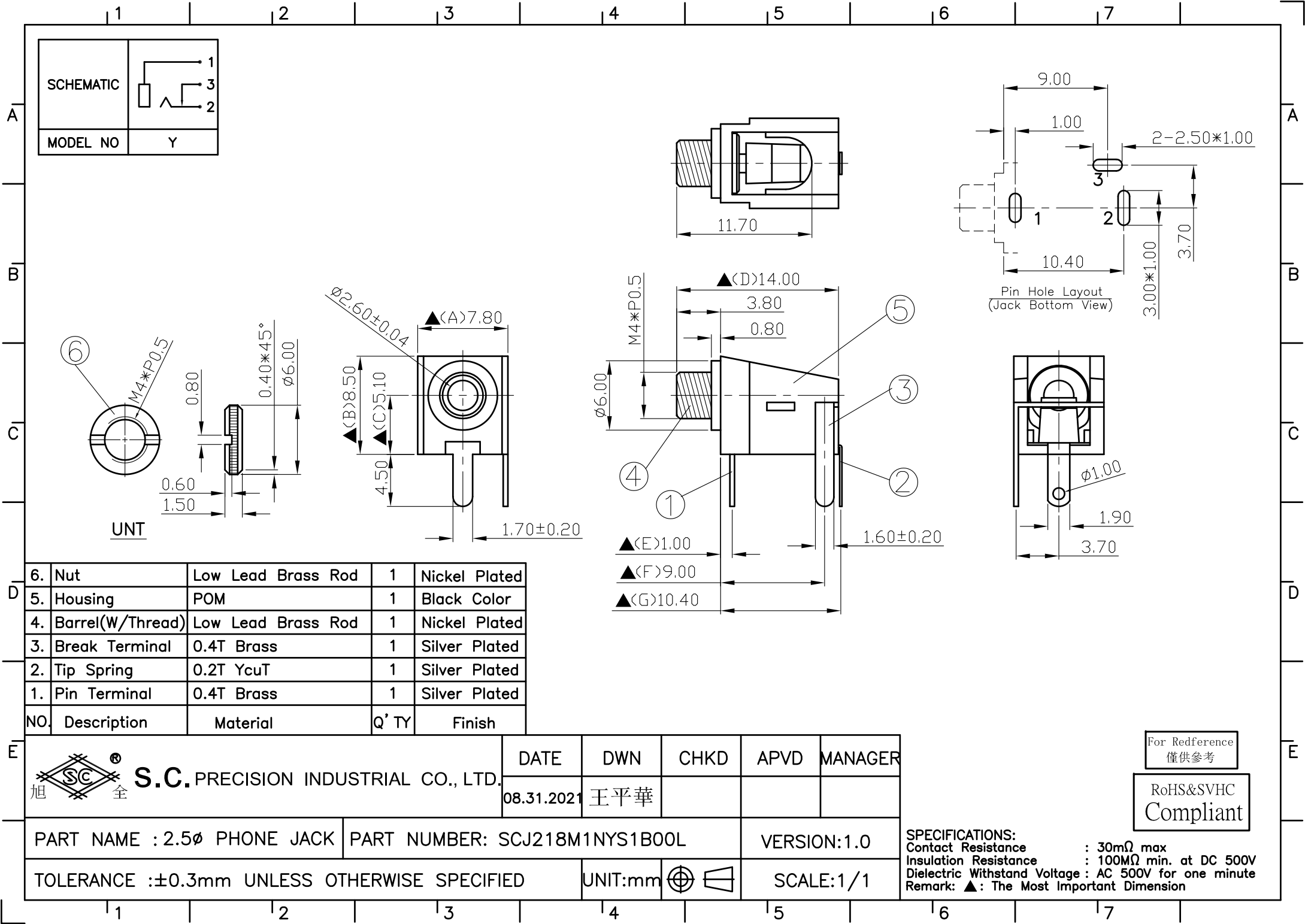
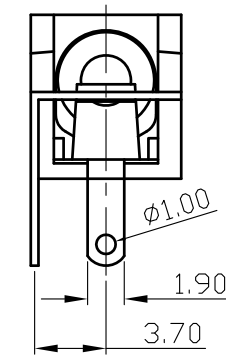
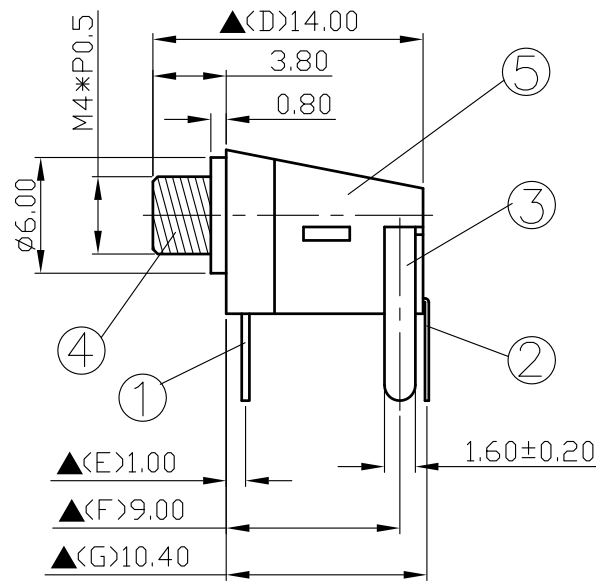
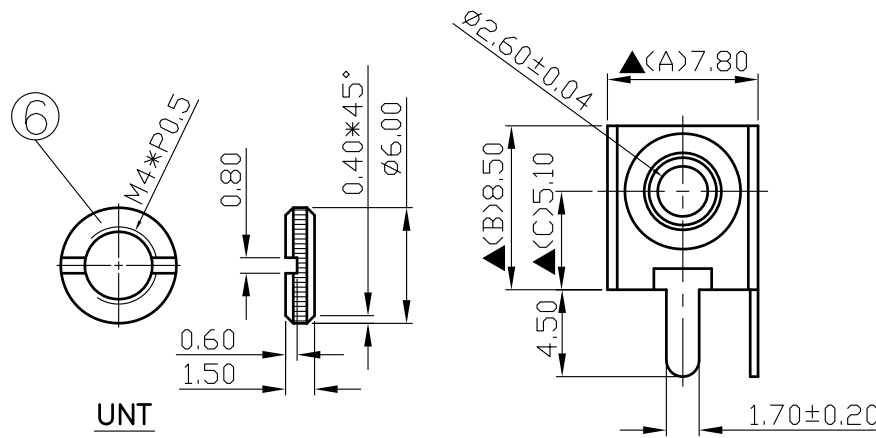
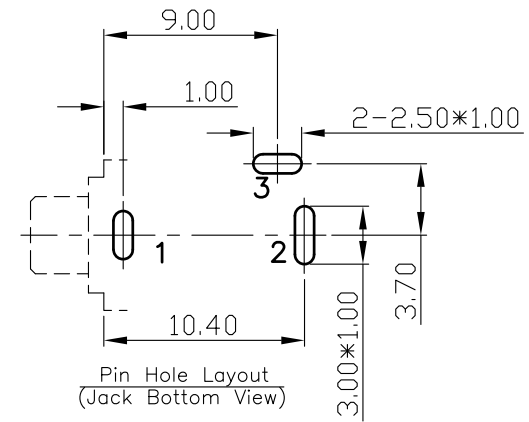
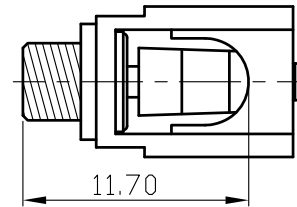




|           |   |
|-----------|---|
| SCHEMATIC |   |
| MODEL NO  | Y |



|     |                  |                    |       |               |
|-----|------------------|--------------------|-------|---------------|
| 6.  | Nut              | Low Lead Brass Rod | 1     | Nickel Plated |
| 5.  | Housing          | POM                | 1     | Black Color   |
| 4.  | Barrel(W/Thread) | Low Lead Brass Rod | 1     | Nickel Plated |
| 3.  | Break Terminal   | 0.4T Brass         | 1     | Silver Plated |
| 2.  | Tip Spring       | 0.2T YcuT          | 1     | Silver Plated |
| 1.  | Pin Terminal     | 0.4T Brass         | 1     | Silver Plated |
| NO. | Description      | Material           | Q' TY | Finish        |

|            |     |      |      |         |
|------------|-----|------|------|---------|
| DATE       | DWN | CHKD | APVD | MANAGER |
| 08.31.2021 | 王平華 |      |      |         |

|                                              |                               |             |
|----------------------------------------------|-------------------------------|-------------|
| PART NAME : 2.5mm PHONE JACK                 | PART NUMBER: SCJ218M1NYS1B00L | VERSION:1.0 |
| TOLERANCE :±0.3mm UNLESS OTHERWISE SPECIFIED | UNIT:mm                       | SCALE:1/1   |

SPECIFICATIONS:  
Contact Resistance : 30mΩ max  
Insulation Resistance : 100MΩ min. at DC 500V  
Dielectric Withstand Voltage : AC 500V for one minute  
Remark: ▲: The Most Important Dimension

For Redference  
僅供參考  
RoHS&SVHC  
Compliant